

# Surface Mount Directional Coupler

## TCD-6-122-75X+

75Ω 6.7 dB 5 to 1250 MHz



Generic photo used for illustration purposes only

CASE STYLE: AT1521

**+RoHS Compliant**

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

**Available Tape and Reel at no extra cost**

Reel Size	Devices/Reel
7"	20, 50, 100, 200, 500
13"	1000, 2000

### Features

- wideband, 5 to 1250 MHz
- low mainline loss, 2.5 dB typ.
- aqueous washable
- leads for excellent solderability
- protected by US Patent 6,140,887

### Applications

- DOCSIS® 3.1 Systems
- VHF/UHF
- CATV
- cellular

### Electrical Specifications at 25°C

Parameter	Condition (MHz)	Min.	Typ.	Max.	Unit
<b>Frequency Range</b>		5		1250	MHz
<b>Mainline Loss<sup>1</sup></b> (above theoretical 0.1 dB)	5-100	—	2.2	2.8	dB
	100-1000	—	2.3	2.9	
	1000-1250	—	2.8	3.5	
<b>Nominal Coupling</b>	5-1250	—	6.7±0.3	—	dB
<b>Coupling Flatness(±)</b>	5-1250	—	±0.2	±0.5	dB
<b>Directivity</b>	5-100	13	15	—	dB
	100-1000	10	13	—	
	1000-1250	8	12	—	
<b>Return Loss (Input)</b>	5-100	10	15	—	dB
	100-1000	14	16	—	
	1000-1250	13	15	—	
<b>Return Loss (Output)</b>	5-100	15	20	—	dB
	100-1000	15	18	—	
	1000-1250	13	18	—	
<b>Return Loss (Coupling)</b>	5-100	10	14	—	dB
	100-1000	13	15	—	
	1000-1250	13	16	—	
<b>Input Power</b>	5-500	—	—	0.3	W
	500-1250	—	—	0.5	

1. Mainline loss includes theoretical power loss 1.1dB at coupled port.

### Maximum Ratings

Parameter	Ratings
Operating Temperature	-40°C to 85°C*
Storage Temperature	-55°C to 100°C

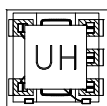
Permanent damage may occur if any of these limits are exceeded.

\* Case temperature is defined as temperature on ground leads.

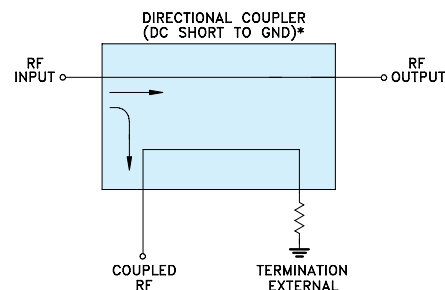
### Pin Connections

Function	Pin Number
INPUT	3
OUTPUT	4
COUPLED	1
GROUND	2
75Ω TERM EXTERNAL	6

### Product Marking

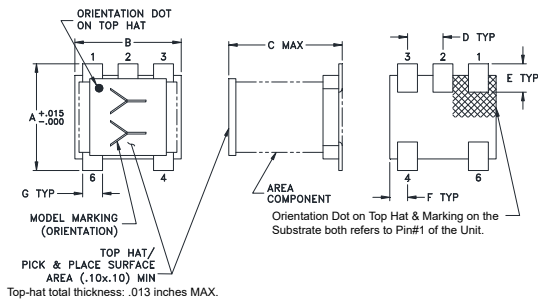


### Electrical Schematic

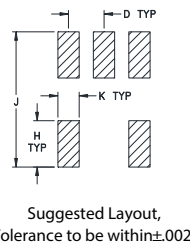


\* ELECTRICAL SCHEMATIC IS FOR DIRECTIONAL COUPLER WITH INTERNAL TRANSFORMER(S) AND EXTERNAL TERMINATION.

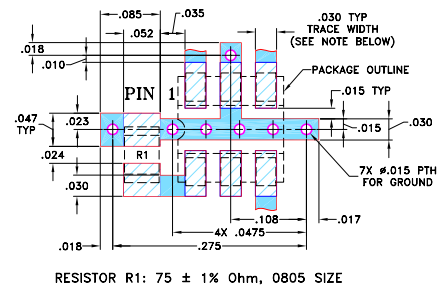
## Outline Drawing



## PCB Land Pattern



## Demo Board MCL P/N: TB-72 Suggested PCB Layout (PL-010)



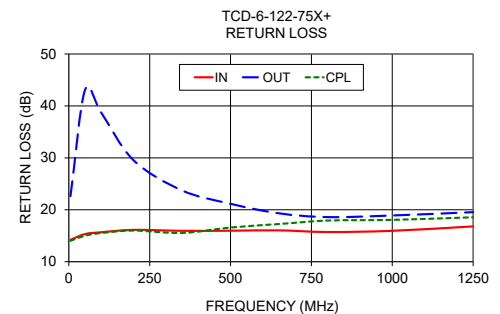
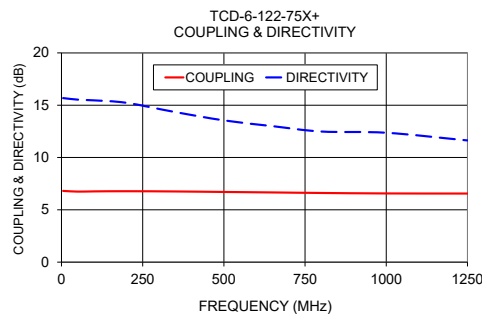
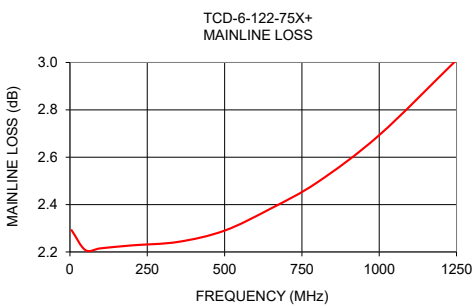
- NOTES:**
- TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS 0.030" ± 0.002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
  - BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
  - DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

## Outline Dimensions (inch/mm)

A	B	C	D	E	F	G	H	J	K	wt
.150	.150	.160	.050	.040	.025	.028	.065	.190	.030	grams
3.81	3.81	4.06	1.27	1.02	0.64	0.71	1.65	4.83	0.76	0.15

## Typical Performance Data

Frequency (MHz)	Mainline Loss (dB) In-Out	Coupling (dB) In-Cpl	Directivity (dB)	Return Loss (dB)		
				In	Out	Cpl
5	2.29	6.81	15.68	14.24	22.63	14.03
50	2.21	6.74	15.53	15.33	43.05	15.02
100	2.22	6.76	15.46	15.68	38.71	15.53
200	2.23	6.78	15.23	16.14	29.54	16.00
350	2.24	6.76	14.34	15.95	23.73	15.55
500	2.29	6.71	13.55	15.97	21.16	16.59
650	2.38	6.66	13.00	16.04	19.32	17.26
800	2.49	6.61	12.48	15.72	18.60	17.93
1000	2.69	6.57	12.37	15.96	18.91	18.06
1250	3.01	6.56	11.63	16.81	19.55	18.56



## Additional Notes

- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
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# Directional Coupler

# TCD-6-122-75X+

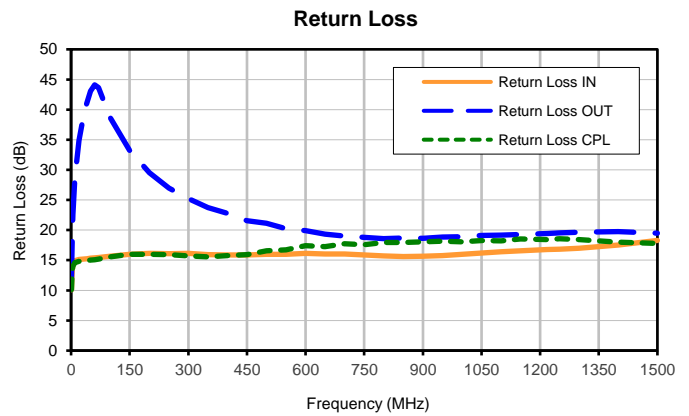
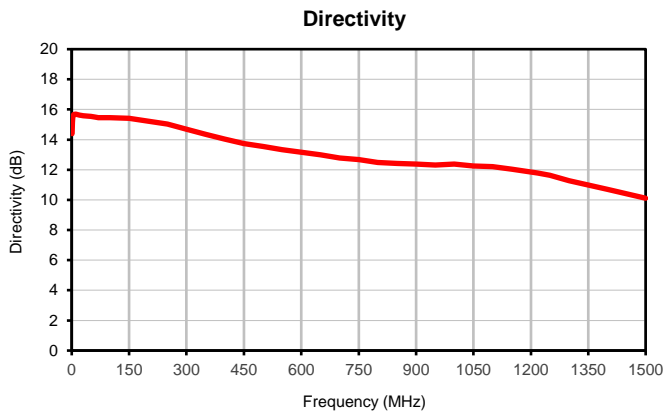
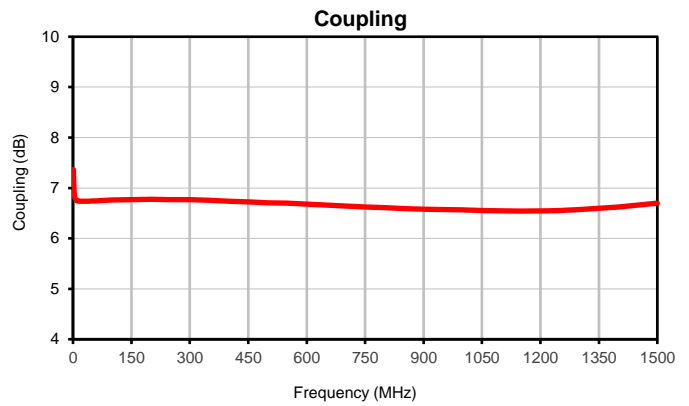
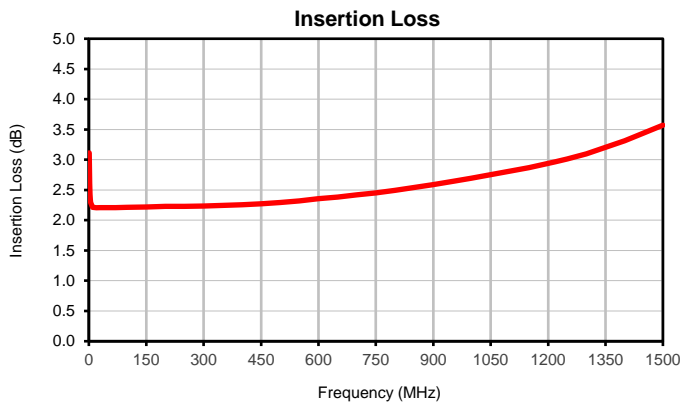
## Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	COUPLING (dB)	DIRECTIVITY (dB)	RETURN LOSS (dB)		
				IN	OUT	CPL
1	3.11	7.36	14.40	10.10	11.90	10.12
2	2.61	7.01	15.13	12.30	16.07	12.22
3	2.43	6.90	15.45	13.31	18.80	13.18
4	2.35	6.84	15.60	13.87	20.90	13.71
5	2.29	6.81	15.68	14.24	22.63	14.03
10	2.21	6.74	15.69	14.91	28.56	14.62
20	2.21	6.73	15.62	15.12	34.90	14.80
30	2.21	6.74	15.58	15.18	38.36	14.86
40	2.21	6.74	15.55	15.26	40.98	14.93
50	2.21	6.74	15.53	15.33	43.05	15.02
60	2.21	6.74	15.50	15.40	44.11	15.10
70	2.21	6.75	15.46	15.48	43.66	15.16
100	2.22	6.76	15.46	15.68	38.71	15.53
150	2.22	6.77	15.42	15.96	33.23	15.96
200	2.23	6.78	15.23	16.14	29.54	16.00
250	2.23	6.77	15.02	16.09	26.98	15.94
300	2.23	6.77	14.68	16.12	25.21	15.71
350	2.24	6.76	14.34	15.95	23.73	15.55
400	2.26	6.74	14.03	15.89	22.80	15.75
450	2.27	6.73	13.73	15.85	21.58	15.91
500	2.29	6.71	13.55	15.97	21.16	16.59
550	2.32	6.70	13.34	16.00	20.21	16.73
600	2.35	6.68	13.17	16.12	19.91	17.40
650	2.38	6.66	13.00	16.04	19.32	17.26
700	2.42	6.64	12.79	16.04	19.01	17.73
750	2.45	6.62	12.67	15.86	18.82	17.57
800	2.49	6.61	12.48	15.72	18.60	17.93
850	2.54	6.59	12.41	15.61	18.71	17.95
900	2.59	6.58	12.38	15.64	18.61	18.08
950	2.64	6.57	12.31	15.77	18.87	18.16
1000	2.69	6.57	12.37	15.96	18.91	18.06
1050	2.75	6.56	12.24	16.20	19.10	18.27
1100	2.81	6.55	12.21	16.41	19.16	18.22
1150	2.87	6.54	12.03	16.57	19.26	18.52
1218	2.96	6.55	11.78	16.76	19.42	18.42
1250	3.01	6.56	11.63	16.81	19.55	18.56
1300	3.10	6.57	11.28	16.97	19.65	18.43
1400	3.31	6.62	10.70	17.51	19.76	18.00
1500	3.57	6.70	10.11	18.29	19.48	17.77

# Directional Coupler

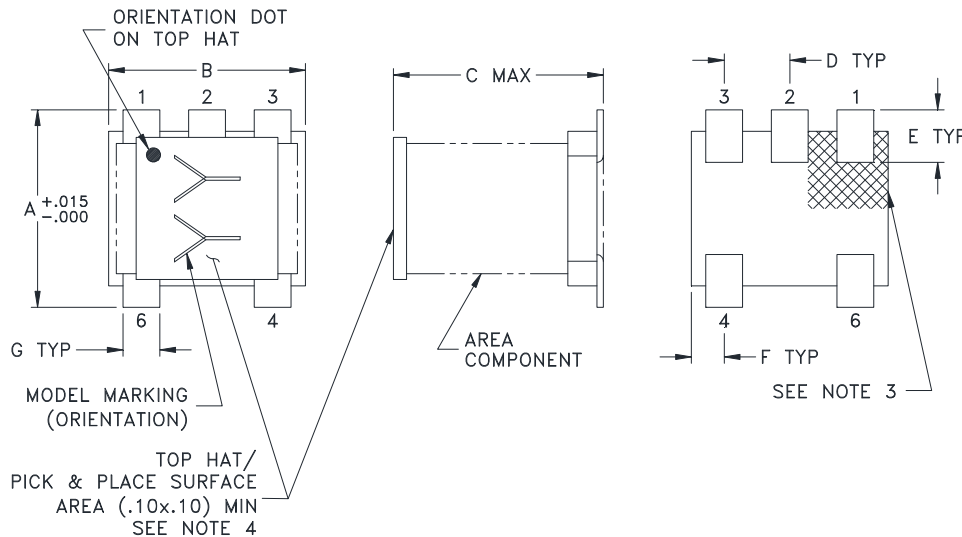
# TCD-6-122-75X+

## Typical Performance Curves



## Outline Dimensions

AT1521



## PCB Land Pattern

Suggested Layout,  
Tolerance to be within  $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAMS
AT1521	.150 (3.81)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (.64)	.028 (.71)	.065 (1.65)	.190 (4.83)	.030 (.76)	.15

Dimensions are in inches (mm). Tolerances: 2 Pl.  $\pm .01$ ; 3 Pl.  $\pm .005$

### Notes:

1. Case material: Plastic.
2. Termination finish:  
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
3. Orientation Dot on Top Hat & Marking on the Substrate both refers to Pin #1 of the Unit.
4. Top-Hat total thickness: .013 inches MAX.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



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RF/IF MICROWAVE COMPONENTS

# Tape & Reel Packaging TR-F17

## DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
		13	Standard	1000
		2000		

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: [www.minicircuits.com/pages/pdfs/tape.pdf](http://www.minicircuits.com/pages/pdfs/tape.pdf)



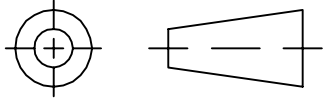
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RF/IF MICROWAVE COMPONENTS

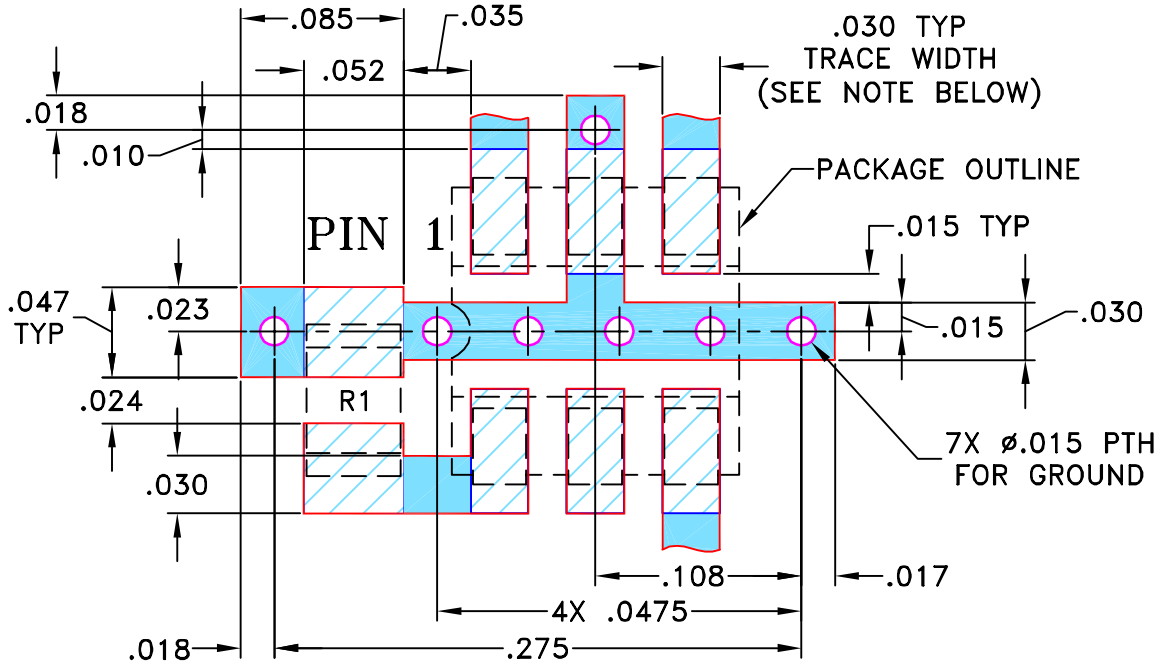
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M73159	NEW RELEASE	08/00	IL	DB
A	M82377	UPDATED DRAWING	07/30/02	AV	LC
B	M102713	UPDATED NOTES	01/12/08	GF	IL

SUGGESTED MOUNTING CONFIGURATION FOR  
DB714 CASE STYLE, "mm" PIN CONNECTION



RESISTOR R1: 75 ± 1% Ohm, 0805 SIZE

- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS 0.030" ± 0.002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN IL	08/03/00
TOLERANCES ON:	CHECKED WP	08/08/00
2 PL DECIMALS ±	APPROVED DB	08/09/00
3 PL DECIMALS ± .005		
ANGLES ±		
FRACTIONS ±		

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Brooklyn NY 11235

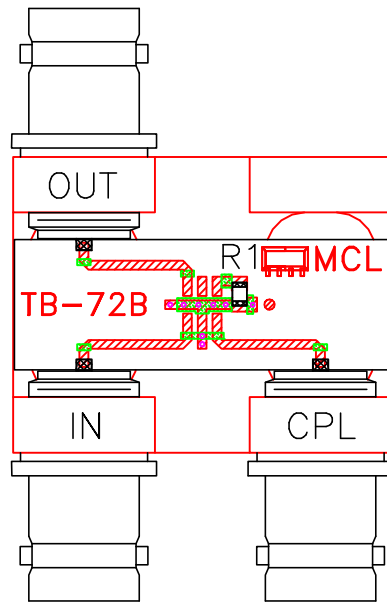
PL, mm, 75, DB714, TCD, TB-72

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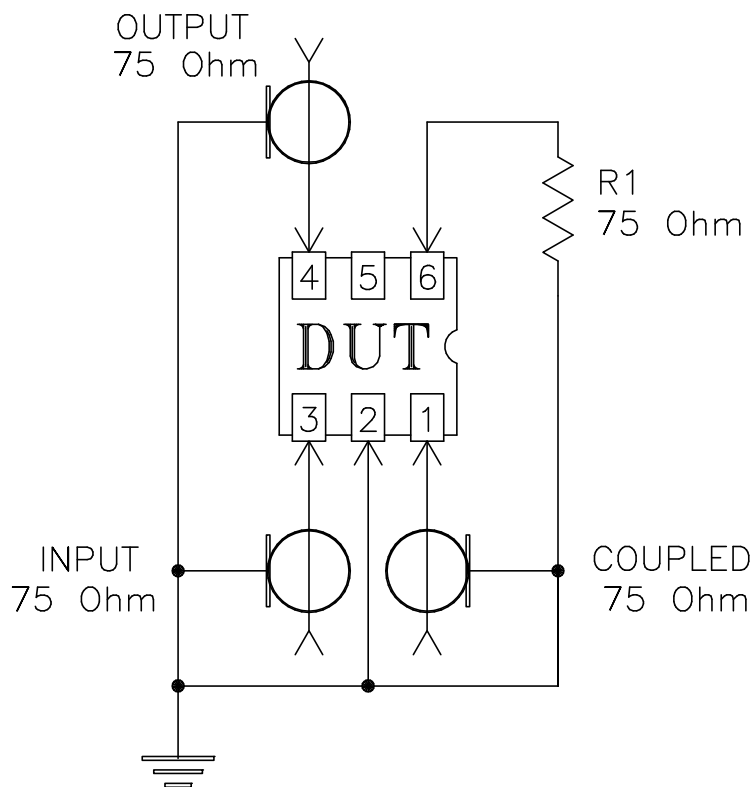
ASHEETA1.DWG REV:A DATE:01/12/95

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-010	B
FILE:	98PL010	SCALE:	10:1
		SHEET:	1 OF 1

# Evaluation Board and Circuit




TB-72



Schematic Diagram

## Notes:

1. 75 Ohm BNC Female connectors.
2. PCB Material: Rogers R04350 or equivalent,  
Dielectric Constant=3.5, Thickness=.030 inch.

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All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215